APPLICA	BLE STAN	DARD										
Operating		\wedge	A 55.00 t 405.00(1)			Storage			-10 °C to 60 °C (2)			
	Temperature Range 2		Signal Contact : 50 V AC			mperature Range			Relative humidity 85% max (Not dewed)			
Rating			Power Contact : 200 V AC Signal Contact : 0.5 A			orage Humidity Range						
	Current		Power Contact : 3.0A			perating Humidity Range						
	•		SPEC	IFICA	TION	S						
IT	EM		TEST METHOD				REC	UIR	EMENTS	QT	АТ	
CONSTRU		1			Į					1	1	
General Examination		Visually and by measuring instrument.				According to drawing.					×	
Marking		Confirmed visually.									×	
ELECTRIC CHARACT												
Contact Resistance		100 mA(DC or 1000Hz)				Signal Contact : $70m\Omega$ MAX. Power Contact : $20m\Omega$ MAX.				×	_	
Insulation Resistance Voltage Proof MECHANICAL CHAR.		Signal Contact : 100 V DC.				Signal Contact : 100 MΩMIN.					 	
		Power Contact : 250 V DC				Power Contact : 1000 MΩMIN.						
		Signal Contact : 150 V AC for 1 min.				No flashover or breakdown.					×	
		Power Contact : 600 V AC for 1 min.				No hashover of breakdown.					_	
					ı					×	1	
Insertion and Withdrawal Forces		Measured by applicable connector.				Insertion Force: 45 N MAX. Withdrawal Force: 5 N MIN.					_	
Mechanical Operation		100 times insertions and extractions.				Contact Resistance: Signal Contact: 80m Ω MAX. Power Contact: 30m Ω MAX. No damage, crack and looseness of parts.				×	 	
Vibration		Frequency 10 to 55 to 10Hz, approx 5min				① No electrical discontinuity of 1 μs.					 	
		Single amplitude : 0.75 mm, 10 cycles for 3 axial directions.				② No damage, crack and looseness of parts.						
Shock		490 m/s ² , duration of pulse 11 ms at 3 times for 3 both axial directions.								×	-	
FNVIRON	MENTAL C											
Damp Heat	IVIETTI C		at 40±2 °C, 90 ~ 95 %,	. 96 h.		① Cor	ntact Resist	tance:		×	_	
(Steady state)						_	ignal Conta		80m Ω MAX.			
Rapid Change of		Temperature -55 → +85 °C				Power Contact : 30m Ω MAX.				×	_	
Temperature		Time $30 \rightarrow 30$ min.				_	ulation Res					
		under 5 cycles. (Relocation time to chamber : within 2~3 MIN)				Signal Contact : 100 MΩ MIN. Power Contact : 1000 MΩ MIN.						
Cold		Exposed at -55°C, 96 h				③ No damage, crack and looseness of parts.① Contact Resistance:				×	-	
D						Signal Contact : 80m Ω MAX.						
Dry Heat	<u>/2</u> \	Exposed at 105°C, 96 h				Power Contact: 30m Ω MAX. ② No damage, crack and looseness of parts.				×	_	
Sulfur Dioxide		Exposed at 25±2°C, 75±5%RH, 25 PPM for 96 h. (Test standard: IEC 68)				No defect such as corrosion which impairs the function of connector. Contact Resistance:					 	
						S	ignal Conta	act:	80m Ω MAX. 30m Ω MAX.			
Resistance to	Resistance to		soldering :			Power Contact : 30m Ω MAX. No deformation of case of excessive				×	 	
Soldering Heat		Peak TMP : 260°CMAX Reflow TMP: 220°CMIN for 60sec				looseness of the terminal.						
			ng irons : 360°C MAX. for 5	sec.								
-			Soldered at solder temperature			A new uniform coating of solder shall cover a					_	
		240±3°C for immersion duration, 3 sec.				minimum of 95 % of the surface being immersed.						
COUN	T D	DESCRIPTION OF REVISIONS DE		DESIG	IGNED		CHECKED			ΛTE		
<u>/</u> 2\ 2			F-00002062	TS. 00		ONO			HT. YAMAGUCHI	MAGUCHI 17.02		
REMARKS (1) Include temper		ature rise caused by current-carrying.				APPROVED			HS. OKAWA	14. 04. 2 14. 04. 2		
(2) "STORAGE" means a long-tour before assembly to PCB.			g-term storage state for the unused product			CHECKED DESIGNED		D	KN. SHIBUYA			
								D	TS. 00N0	14. 04. 23		
Unless otherwise specified, refer to II			to IEC 60512.	IEC 60512.			DRAWN	1	TS. 00N0	14. 0)4. 23	
Note QT:Qualification Test AT:Assurance Test X:Applicable Test					DF	<u> </u>			ELC-353548-0	53548-00-00		
HS.	S	SPECIFICATION SHEET			PART	NO.		FX2	3-100P-0. 5SV2	0		
FORM HD0011-2-1		ROSE ELECTRIC CO., LTD.			CODE	E NO. CL573-3105-6-00			3105-6-00	<u>^2</u>	1/1	